IPC ASSOCIATION CONNE	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information			
upplier Info	ormation								·					
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2024-04-23			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-St	tewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
uthorized Rep	resentative*		Title - Representative			P	Phone - Representative*				Email - Representative*			
Product-Env-St	tewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
Requ	uester Item Number	Mfr Item Number		Mfr Item Name]	Effective Date	Version	Manufacturing Site		W	eight*	UOM	Unit Type
		NSVT856	VT856MTWFTBG Dual 65V/100mA, NPN Transistors, XDFNW3		NPN & PNP Bipo W3	olar 2	2024-04-23		MY	MY1		533	mg	Each
Ianufacturi	ng Proccess Informati	ion												
Terminal Plating / Grid Array Material T			Terminal Base Alloy J-STD-020 MSL R		ating	Peak Process Body Temperature Max Time at P			Max Time at Peak	ak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		C	CU Alloy 1				260	C		30	seconds	3		
omments														
vel 1 - maximu	ım time at peak temperatur	e during solo	dering is 10-3	0 seconds										
or more inforn	nation regarding material c	omposition n	olease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	erial Weight Unit of Measure Level Substance		CAS	Exempt	Weight	Unit of Measure		
Die	0.013	mg	Supplier	Silicon (Si)	7440-21-3		0.013	mg
Die Attach Tape	0.017	mg	Supplier	Formaldehyde, polymer with amiline	67784-74-1		0.0011	mg
			Supplier	Amines, C36-alkylenedi-, polymers with 5,5'-[(1-methylethylidene)bis(4,1-phenyleneoxy)]bis[1,3-isobenzofurandione], maleated	1224691-98-8		0.0011	mg
			Supplier	Bisphenol A, epichlorohydrin polymer	68610-41-3		0.0011	mg
			Supplier	Silver (Ag)	7440-22-4		0.0137	mg
Lead Frame	1.02	mg	Supplier	Silver (Ag)	7440-22-4		0.0672	mg
			Supplier	Tin (Sn)	7440-31-5		0.0025	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0022	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0025	mg
			Supplier	Copper (Cu)	7440-50-8		0.9454	mg
Mold Compound-Black	0.48		Supplier	Silica Amorphous (SiO2)	7631-86-9		0.036	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0024	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.3816	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.024	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.036	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond	0.003	_	Supplier	Palladium (Pd)	7440-05-3		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.003	mg